TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSVII)

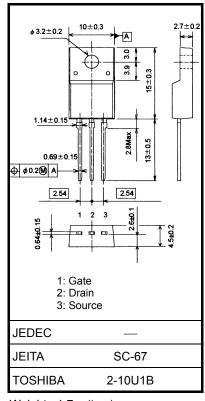
TK18A50D

Switching Regulator Applications

- Low drain-source ON resistance: $RDS(ON) = 0.22 \Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 8.5 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 500 \ V)$
- Enhancement-mode: $V_{th} = 2.0$ to 4.0 V ($V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$)

Characteristics			Symbol	Rating	Unit	
Drain-source voltage			V _{DSS}	500	V	
Gate-source voltage			V _{GSS}	±30	V	
Drain current	DC	(Note 1)	I _D	18	^	
	Pulse	(Note 1)	I _{DP}	72	A	
Drain power dissipation (Tc = 25° C)			PD	50	W	
Single pulse avalanche energy (Note 2)			E _{AS}	533	mJ	
Avalanche current			I _{AR}	18	A	
Repetitive avalanche energy (Note 3)			E _{AR}	5.0	mJ	
Channel temperature			T _{ch}	150	°C	
Storage temperature range			T _{stg}	-55 to 150	°C	

Absolute Maximum Ratings (Ta = 25°C)



Weight : 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

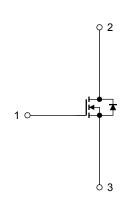
Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to case	R _{th (ch-c)}	2.5	°C/W	
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W	

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 2.8 mH, $R_G = 25 \Omega$, $I_{AR} = 18 \text{ A}$ Note 3: Repetitive rating: pulse width limited by maximum channel temperature This transistor is an electrostatic sensitive device. Please handle with caution.

Note 1: Please use devices on conditions that the channel temperature is below 150°C.

Internal Connection



Start of commercial production 2009-01

Unit: mm

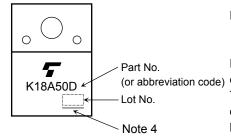
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS}=\pm 30~V,~V_{DS}=0~V$	_		±1	μA
Drain cut-off curr	rent	I _{DSS}	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_		10	μA
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	500		_	V
Gate threshold voltage		V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	2.0		4.0	V
Drain-source ON resistance		R _{DS (ON)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 9 \text{ A}$	_	0.22	0.27	Ω
Forward transfer admittance		Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 9 \text{ A}$	2.4	8.5	_	S
Input capacitance		C _{iss}			2600	_	
Reverse transfer capacitance		C _{rss}	$V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		11	_	pF
Output capacitance		C _{oss}			280		
Switching time	Rise time	tr	$10 V$ $I_D = 9 A$ V_{OUT}		50		- ns
	Turn-on time	t _{on}	$0 \lor - 1 \lor $	_	100	_	
	Fall time	t _f	 ערט ≈ 200 V		25	_	
	Turn-off time	t _{off}	Duty \leq 1%, t _w = 10 μ s	—	150	_	
Total gate charge		Qg		_	45		
Gate-source charge		Q _{gs}	$V_{DD} \approx 400 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 18 \text{ A}$		28		nC
Gate-drain charge		Q _{gd}]	_	17	—	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_	_	18	А
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	72	А
Forward voltage (diode)	V _{DSF}	$I_{DR} = 18 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.7	V
Reverse recovery time	t _{rr}	$I_{DR} = 18 \text{ A}, V_{GS} = 0 \text{ V},$	_	1700	_	ns
Reverse recovery charge	Qrr	dI _{DR} /dt = 100 A/μs	_	26	_	μC

Marking

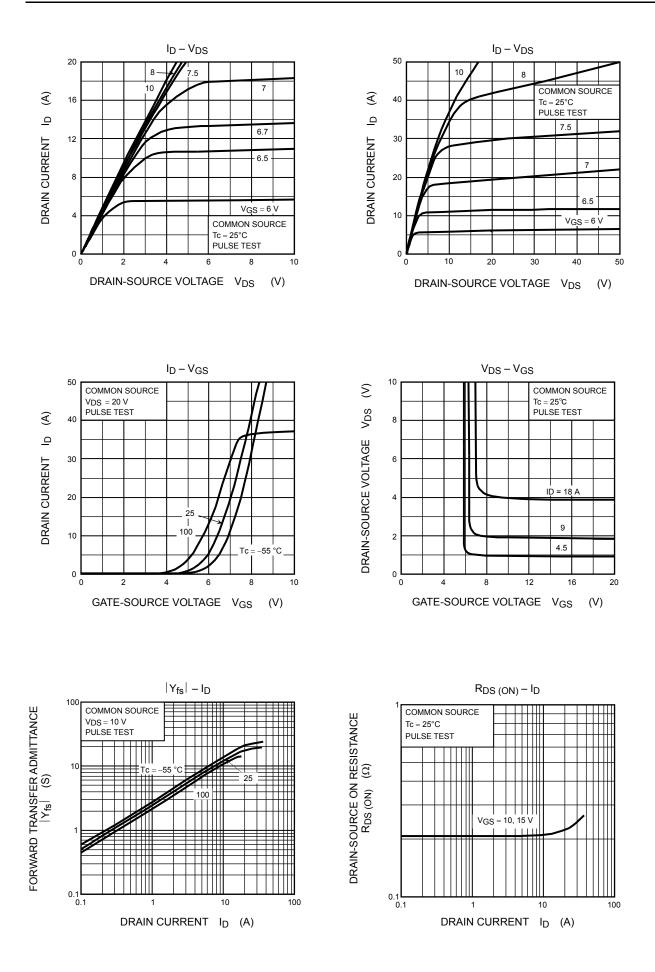


Note 4: A line under a Lot No. identifies the indication of product Labels [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Part No.Please contact your TOSHIBA sales representative for details as to
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-1.5

160

20

16

12

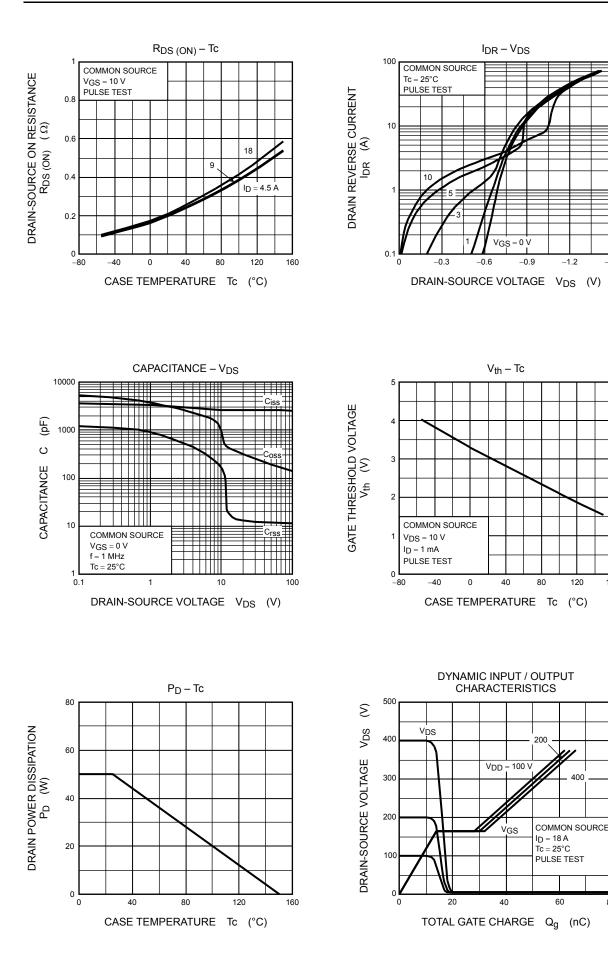
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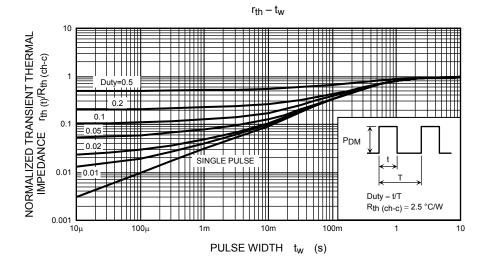
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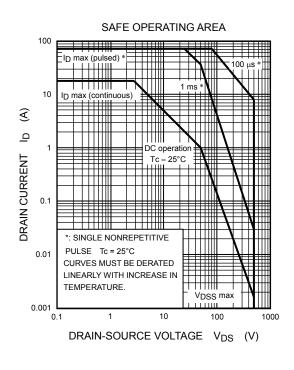
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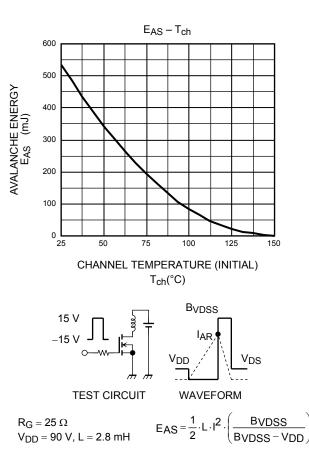
VgS

GATE-SOURCE VOLTAGE









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